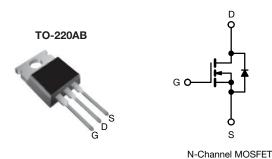


## **Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 5.0 V	0.028		
Q <sub>g</sub> (Max.) (nC)	66			
Q <sub>gs</sub> (nC)	12			
Q <sub>gd</sub> (nC)	43			
Configuration	Single			

#### **FEATURES**

- Dynamic dV/dt rating
- · Logic-level gate drive
- R<sub>DS(on)</sub> specified at V<sub>GS</sub> = 4 V and 5 V
- 175 °C operating temperature
- · Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRLZ44PbF
Lead (Pb)-free and halogen-free	IRLZ44PbF-BE3

<b>ABSOLUTE MAXIMUM RATINGS (TC)</b>	= 25 °C, un	less otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	60	V	
Gate-source voltage			$V_{GS}$	± 10		
Continuous drain current	\/ -+ \( \)	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	,	50		
	V <sub>GS</sub> at 5 V	T <sub>C</sub> = 100 °C	ID	36	Α	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	200		
Linear derating factor			1.0	W/°C		
Single pulse avalanche energy b			E <sub>AS</sub>	400	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		P <sub>D</sub>	150	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	4.5	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175		
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s			300	°C	
Mounting torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 179 \,\mu\text{H}$ ,  $R_q = 25 \,\Omega$ ,  $I_{AS} = 51 \,\text{A}$  (see fig. 12)
- c.  $I_{SD} \le 51$  A,  $dV/dt \le 250$  A/s,  $V_{DD} \le V_{DS}$ ,  $T_{J} \le 175$  °C
- d. 1.6 mm from case
- e. Current limited by the package, (die current = 51 A)



# Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	1.0	

<b>SPECIFICATIONS</b> ( $T_J = 25  ^{\circ}C$ , $t$	ınless otherw	ise noted)					
PARAMETER	SYMBOL	TEST	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0$	60	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 1 mA	-	0.070	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	<sub>GS</sub> , I <sub>D</sub> = 250 μA	1.0	-	2.0	V
Gate-source leakage	I <sub>GSS</sub>	V	<sub>GS</sub> = 10 V	-	-	± 100	nA
Zero gate voltage drain current	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V		$80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$	-	-	25	μΑ
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 48 V, V	V <sub>DS</sub> = 48 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C		-	250	
Drain-source on-state resistance	D	V <sub>GS</sub> = 5.0 V	I <sub>D</sub> = 31 A <sup>b</sup>	-	-	0.028	Ω
	R <sub>DS(on)</sub>	$V_{GS} = 4.0 \text{ V}$	I <sub>D</sub> = 25 A <sup>b</sup>	-	-	0.039	
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 2	$V_{DS} = 25 \text{ V}, I_D = 31 \text{ A}^{\text{ b}}$		-	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	V	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ $f = 1.0 \text{ MHz, see fig. 5}$		3300	-	
Output capacitance	C <sub>oss</sub>	V <sub>I</sub>			1200	-	pF
Reverse transfer capacitance	C <sub>rss</sub>	f = 1.0			200	-	
Total gate charge	Qg			-	-	66	nC
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 5.0 V	$I_D = 51 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 b	-	-	12	
Gate-drain charge	Q <sub>gd</sub>		g. o and ro	-	-	43	
Turn-on delay time	t <sub>d(on)</sub>		V <sub>DD</sub> = 30 V, I <sub>D</sub> = 51 A,		17	-	- ns
Rise time	t <sub>r</sub>	$V_{DD} = 3$			230	-	
Turn-off delay time	t <sub>d(off)</sub>	$R_g = 4.6  \Omega$ , $R_D = 0.56  \Omega$ , see fig. 10 b		-	42	-	
Fall time	t <sub>f</sub>			-	110	-	
Internal drain inductance	L <sub>D</sub>	6 mm (0.25") f	Between lead, 6 mm (0.25") from		4.5	-	nH
Internal source inductance	L <sub>S</sub>	package and center of die contact		_	7.5	-	ווח
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous source-drain diode current	I <sub>S</sub>	showing the	MOSFET symbol showing the		-	50°	_
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	200	A
Body diode voltage	V <sub>SD</sub>	$T_J = 25  ^{\circ}\text{C},  I_S = 51  \text{A},  V_{GS} = 0  \text{V}^{ \text{b}}$		-	-	2.5	V
Body diode reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 51 A, dl/dt = 100 A/μs <sup>b</sup>		-	130	180	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	0.84	1.3	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )					L <sub>D</sub> )

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq$  300 µs; duty cycle  $\leq$  2 %
- c. Current limited by the package, (die current = 51 A)



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

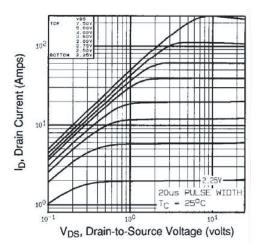


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

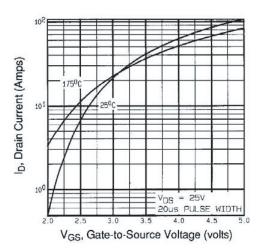


Fig. 3 - Typical Transfer Characteristics

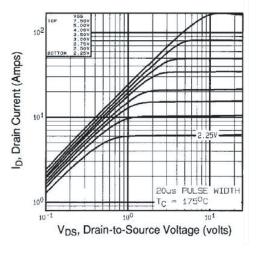


Fig. 2 - Typical Output Characteristics,  $T_C$  = 175 °C

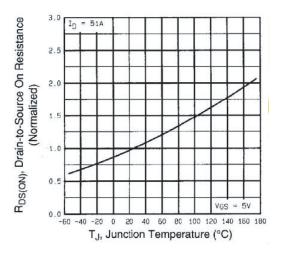


Fig. 4 - Normalized On-Resistance vs. Temperature



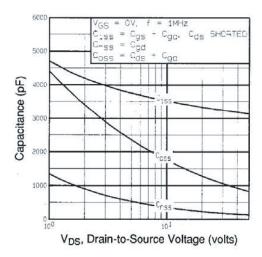


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

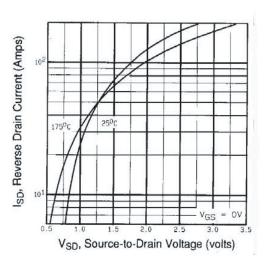


Fig. 7 - Typical Source-Drain Diode Forward Voltage

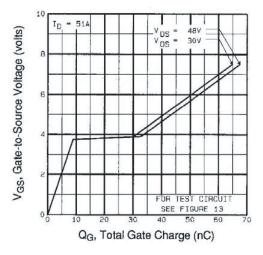


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

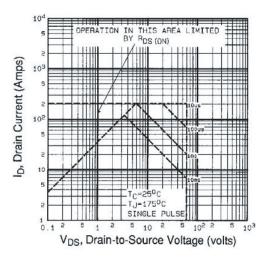


Fig. 8 - Maximum Safe Operating Area



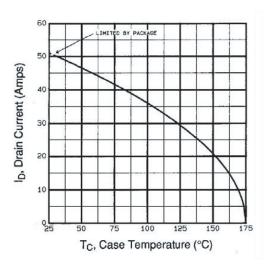


Fig. 9 - Maximum Drain Current vs. Case Temperature

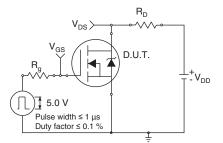


Fig. 10a - Switching Time Test Circuit

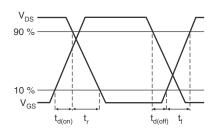


Fig. 10b - Switching Time Waveforms

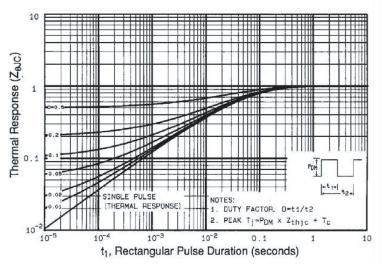
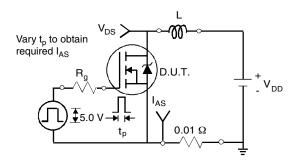
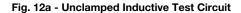


Fig. 10 - Maximum Effective Transient Thermal Impedance, Junction-to-Case







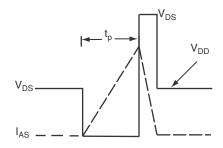


Fig. 12b - Unclamped Inductive Waveforms

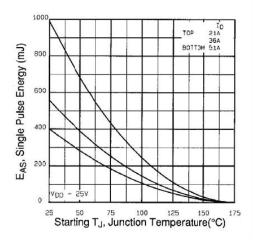


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

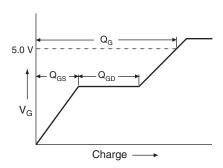


Fig. 13a - Basic Gate Charge Waveform

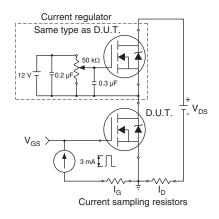
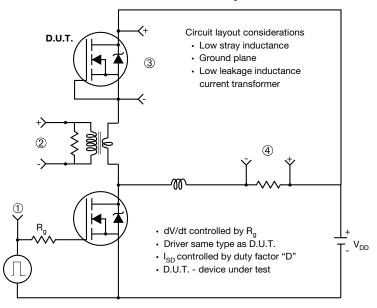


Fig. 13b - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



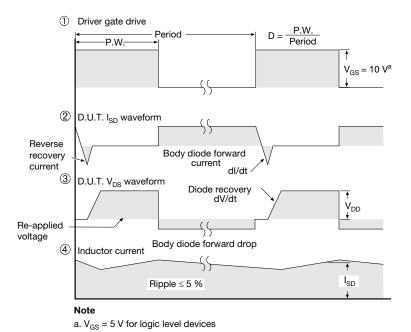


Fig. 11 - For N-Channel

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